

General Description

The N3MNA4P3 is the low $R_{\mbox{\scriptsize DSON}}$ trenched N-CH MOSFETs with robust ESD protection.

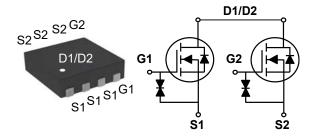
This product is suitable for Lithium-ion battery pack applications.

BV _{DSS}	R _{DS(ON)}	I_D
12 V	4.3 mΩ	56 A

Features

- $R_{DS(ON)} \leq 4.3 m\Omega @V_{GS} = 4.5 V$
- · Super Low Gate Charge
- · Green Device Available
- · Excellent CdV/dt effect decline

DFN3x3 Dual Pin Configuration



Applications

- · Handheld Instruments
- · POL Applications
- · Battery Protection Applications

Absolute Maximum Ratings T_C=25°C unless otherwise noted Symbol **Parameter** Rating Units V_{DS} Drain-Source Voltage 12 ٧ ٧ V_{GS} Gate-Source Voltage ±8 Drain Current - Continuous (T_C=25°C) 56 Α I_D 35.6 Drain Current - Continuous (T_C=100°C) Α Drain Current - Pulsed (NOTE 1) 100 I_{DM} Α P_{D} Power Dissipation (T_C=25°C) 31 W T_{J} Operating Junction Temperature Range -55 to 150 ٥С -55 to 150 T_{STG} Storage Temperature Range ٥С Marking Code NA4P3, A1030

Thermal Characteristics					
Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		35	°C/W	
$R_{ heta JC}$	Thermal Resistance Junction to Case		4	°C/W	





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	12			V
I _{DSS}	IDrain-Source Leakage Current	V_{DS} =12V , V_{GS} =0V , T_{J} =25°C			1	uA
		V_{DS} =12V , V_{GS} =0V , T_{J} =55 $^{\circ}$ C			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±8V , V_{DS} =0V			±10	uA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I Regions	Static Drain-Source On-Resistance (NOTE 1)	V_{GS} =4.5V , I_D =3A		3.3	4.3	
		V_{GS} =4.0V , I_D =3A		3.4	4.4	
		V_{GS} =3.1V , I_D =3A		3.6	4.7	mΩ
		V_{GS} =2.5V , I_D =3A		4.0	5.6	
		V _{GS} =1.8V , I _D =3A		5.4	7.6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	0.4	0.6	1.0	V
gfs	Forward Transconductance	V_{DS} =5V , I_D =3A		42		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge (4.5V)			38		
\mathbf{Q}_{g}	Total Gate Charge (3.9V)	V _{DS} =10V , I _D =3A		33		nC
Q_gs	Gate-Source Charge	V _{DS} -10V , I _D -3A		4.5		IIC
Q_{gd}	Gate-Drain Charge			12		
T _{d(on)}	Turn-On Delay Time	V_{DD} =10V , V_{GS} =4.5V , I_{D} =3A , R_{G} =6 Ω		22		
T _r	Rise Time			41		nS
$T_{d(off)}$	Turn-Off Delay Time			77		113
T_f	Fall Time			21		
C _{iss}	Input Capacitance	V _{DS} =10V , V _{GS} =0V , F=1MHz		3165		
C _{oss}	Output Capacitance			380		pF
C_{rss}	Reverse Transfer Capacitance			325		

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V,Force Current		-	30	Α
I _{SM}	Pulsed Source Current (NOTE 1)				100	Α
V_{SD}	Diode Forward Voltage (NOTE 1)	V_{GS} =0V , I_{S} =3A , T_{J} =25 $^{\circ}$ C			1.2	V

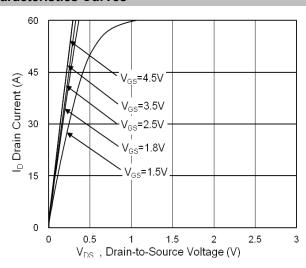
NOTES:

^{1.} The data tested by pulsed , pulse width \leq 10us , duty cycle \leq 1%.





Characteristics Curves



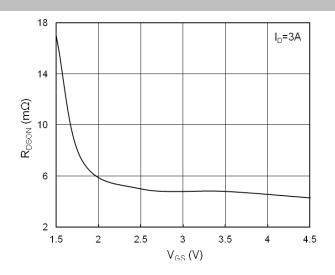
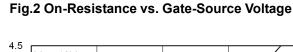
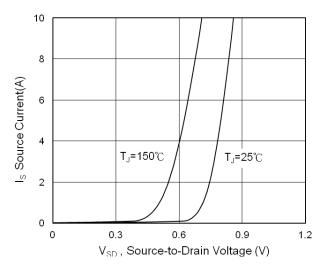


Fig.1 Typical Output Characteristics





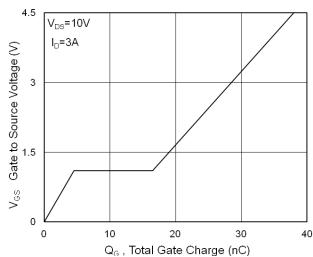
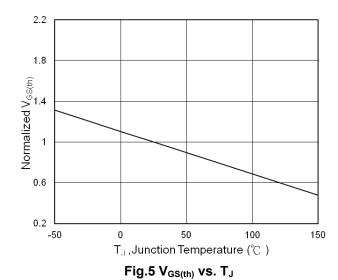
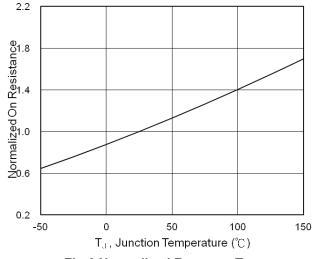


Fig.3 Source Drain Forward Characteristics

Fig.4 Gate-Charge Characteristics









Characteristics Curves

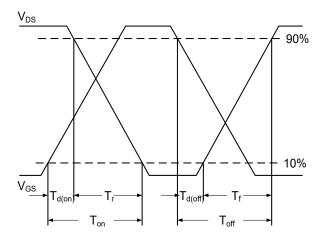


Fig.7 Switching Time Waveform

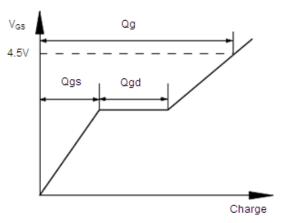
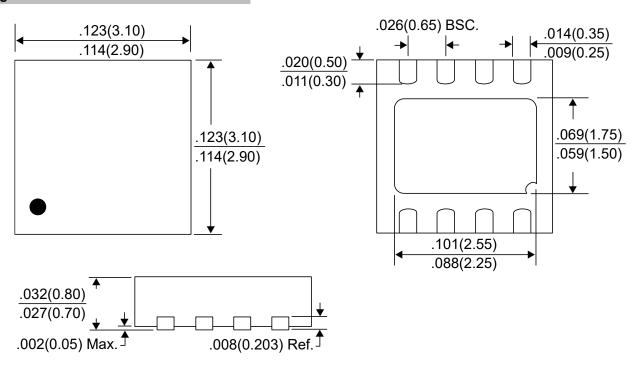


Fig. 8 Gate Charge Waveform

Package Outline Dimensions



DFN3x3

Dimensions in inches and (millimeters)





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